



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

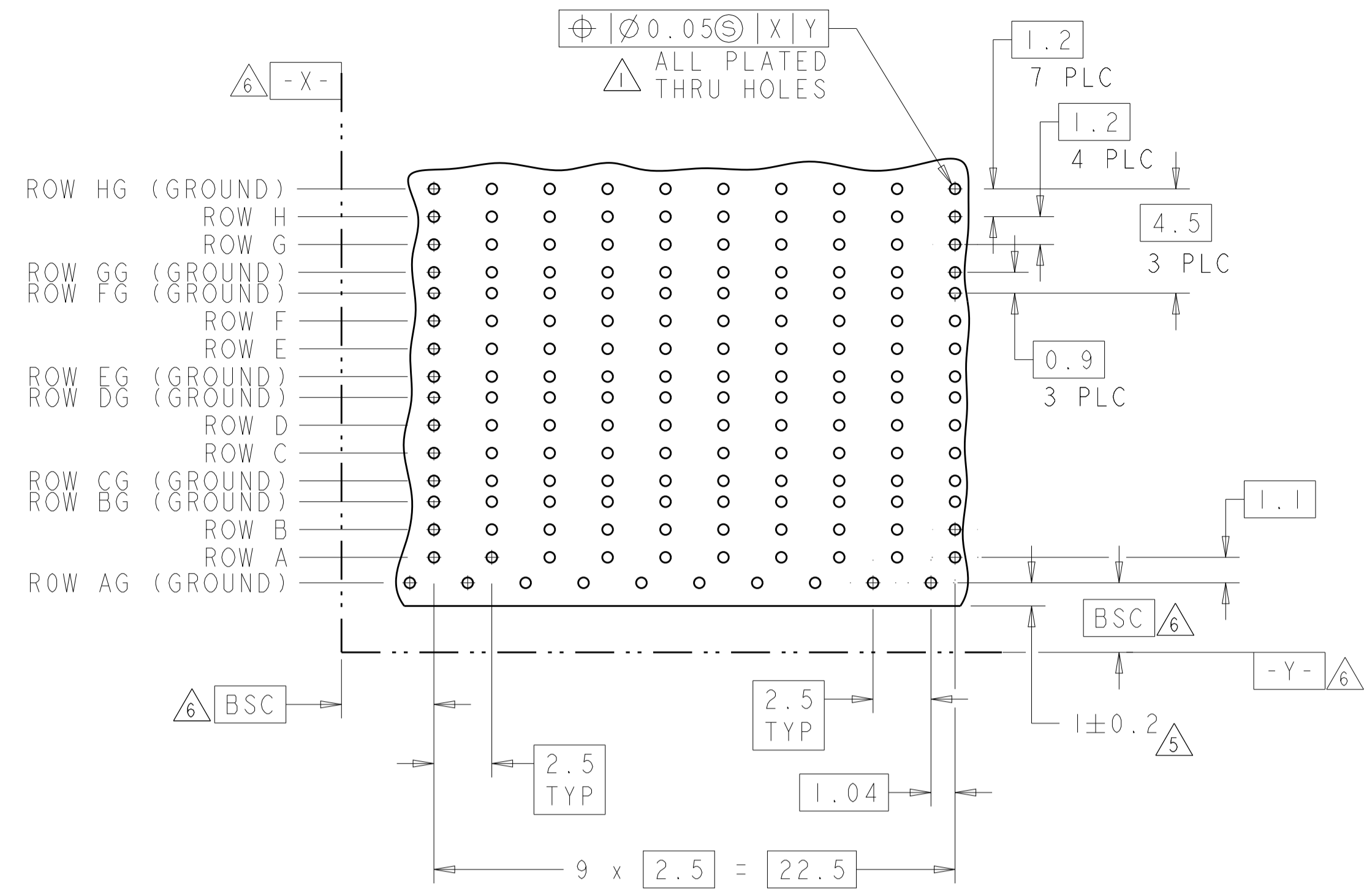
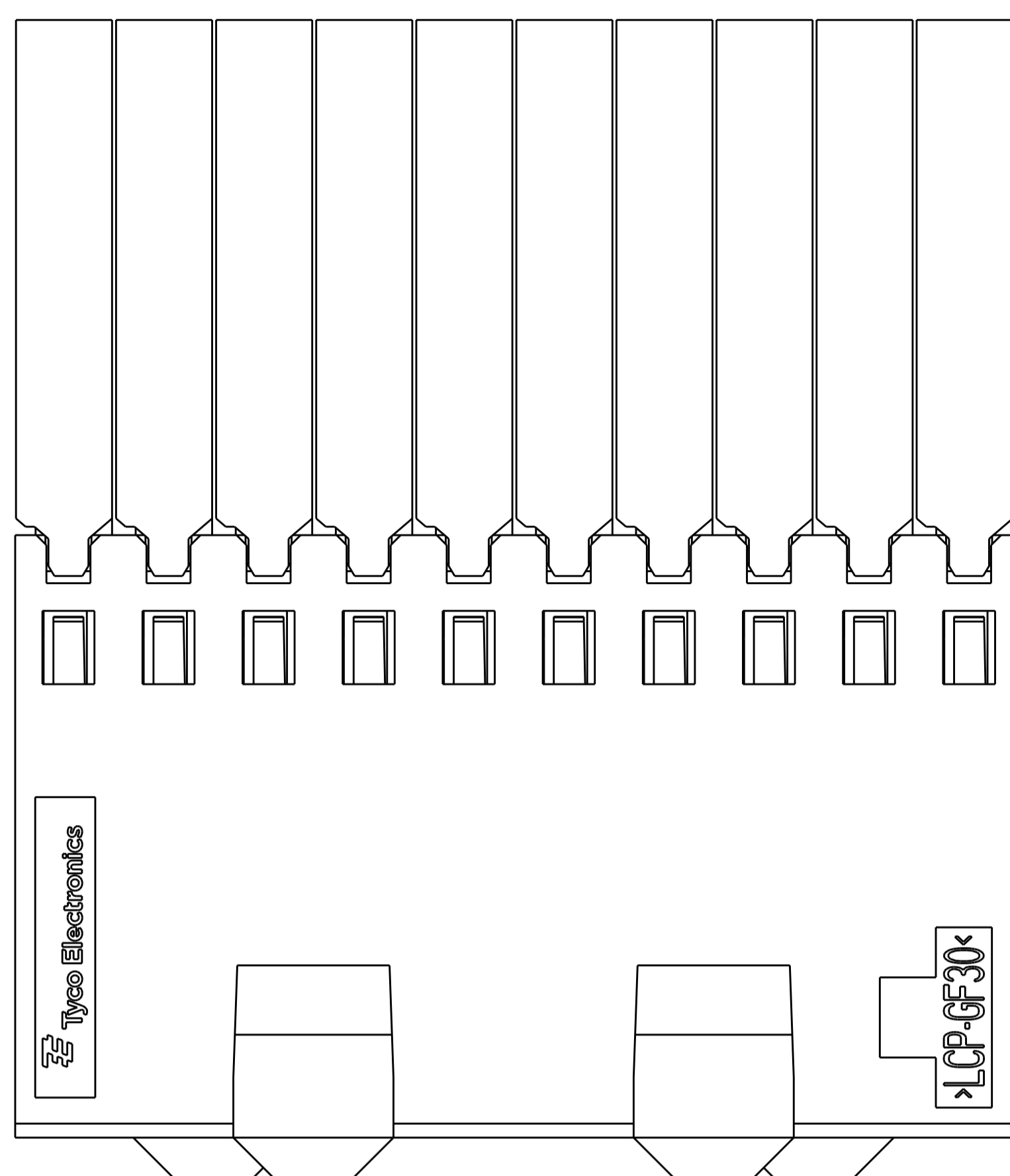
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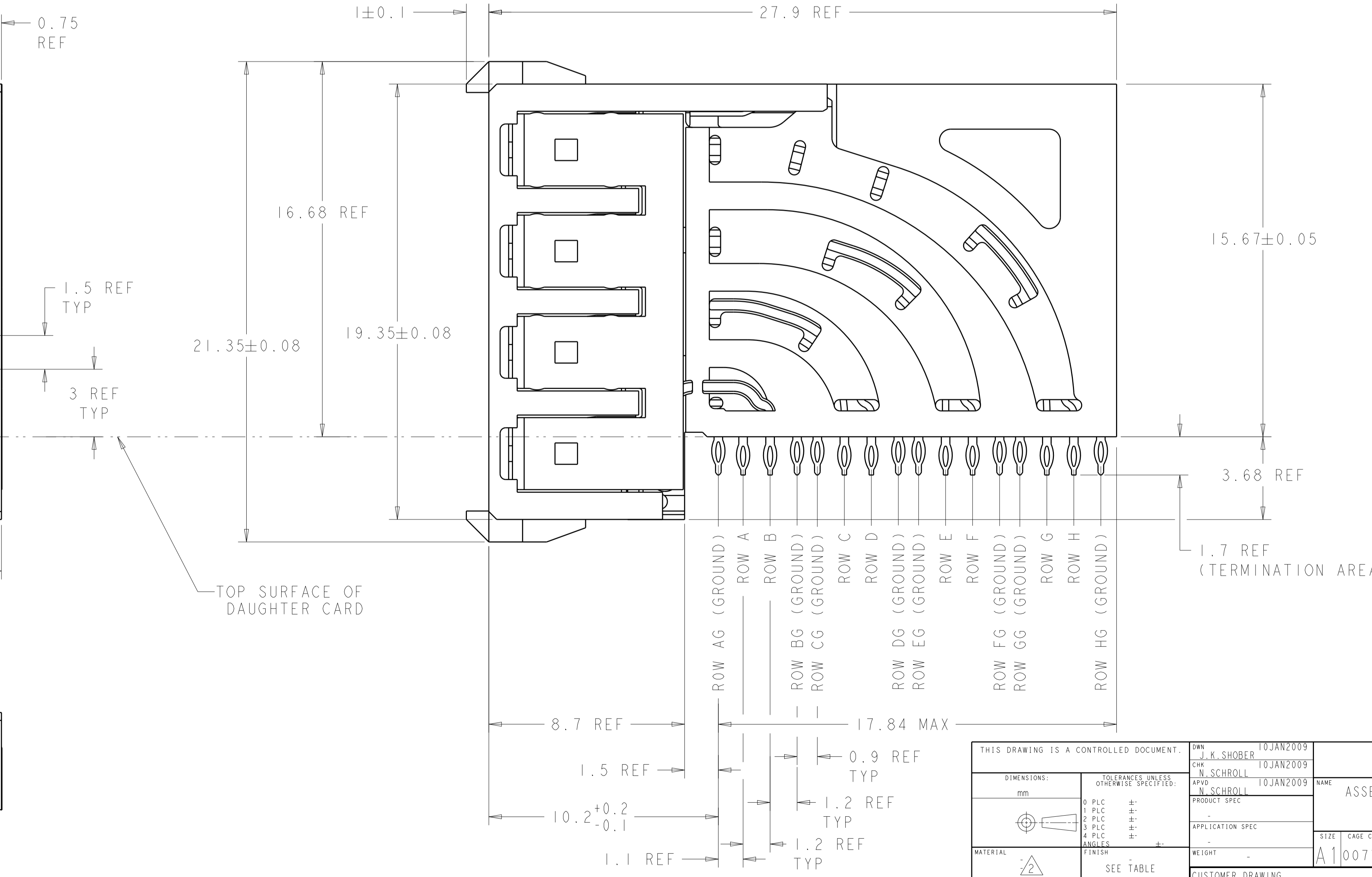
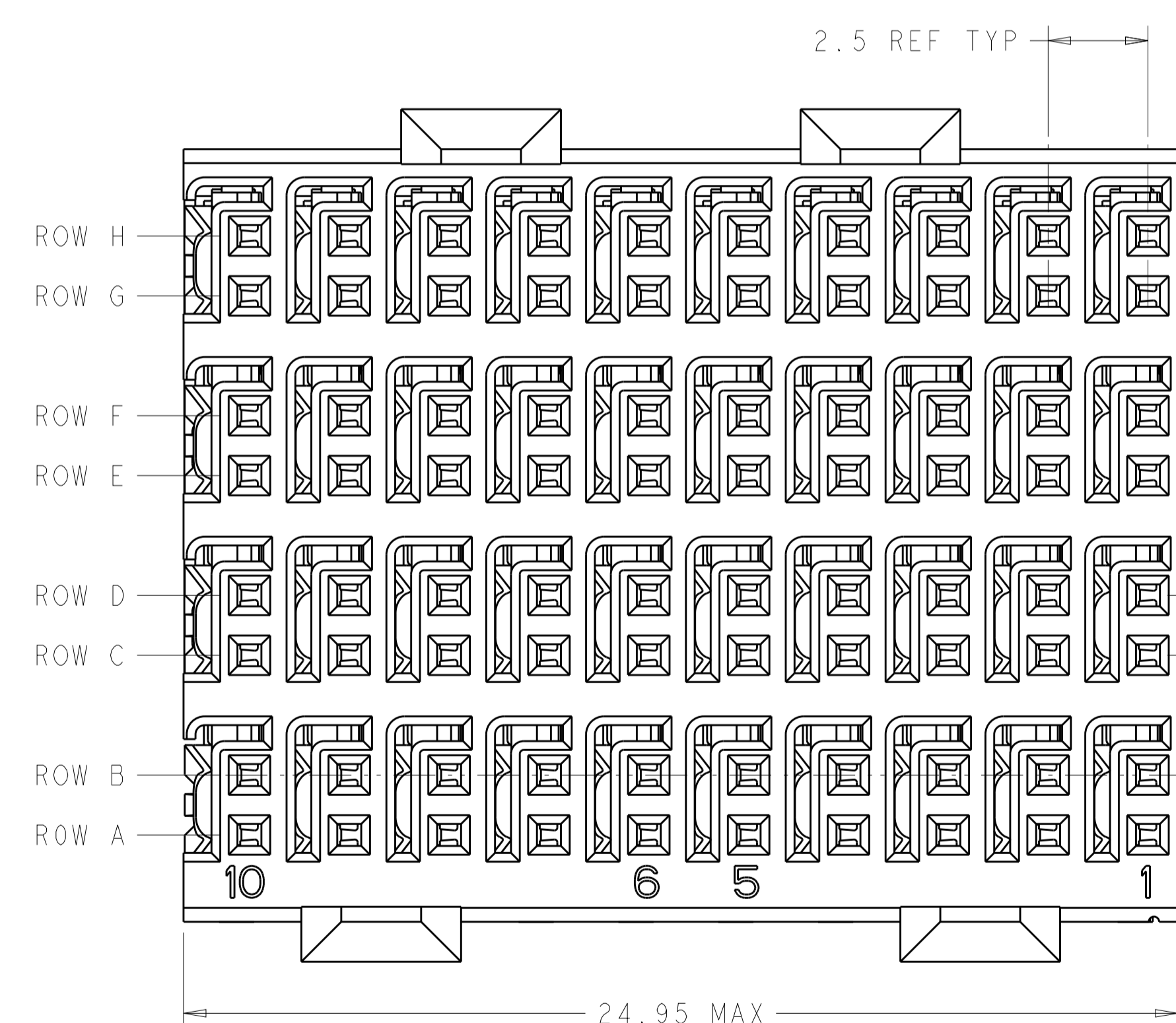


| LOC | | DIST | | REVISIONS | | | |
|-----|----|------|-----|---------------------------|-----------|-----|------|
| AD | 00 | P | LTN | DESCRIPTION | DATE | DWN | APVD |
| | | B | | REVISED PER ECO-12-010079 | 04OCT2012 | KH | JE |



RECOMMENDED PC BOARD LAYOUT,
 DAUGHTER BOARD,
 COMPONENT SIDE SHOWN
 SCALE 5:1

- 1. REFERENCE APPLICATION SPEC 114-13059 FOR RECOMMENDED PLATED THRU HOLE DIAMETER AND PLATING THICKNESSES.
- 2. MATERIAL:
 SHIELD - PHOSPHOR BRONZE
 CONTACT - COPPER-NICKEL-SILICON
 HOUSING, CHICKLET AND CHICKLET COVER - GLASS FILLED POLYESTER, UL 94V-0 RATED.
- 3. FINISH: CONTACT AND SHIELD MATING AREA:
 MEETS THE PERFORMANCE REQUIREMENTS OF TYCO ELECTRONICS PRODUCT SPECIFICATION, 108-2055-1; BASED ON TELCORDIA GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS.
 COMPLIANT PIN AREA:
 0.5µm MIN BRIGHT TIN/LEAD OVER BASE PLATING.
- 4. CONNECTOR MARKED WITH PART NUMBER AND DATE CODE IN APPROXIMATE AREA SHOWN.
- 5. DIMENSION APPLIES TO CENTERLINE OF THRU HOLE.
- 6. DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
- 7. CONTACT AREA LUBRICATED WITH BELLCORE APPROVED LUBRICANT. TECHNICAL REFERENCE: GR-1217-CORE, ISSUE 1, NOVEMBER 1995.
- 8. FINISH: CONTACT AND SHIELD MATING AREA:
 MEETS THE PERFORMANCE REQUIREMENTS OF TYCO ELECTRONICS PRODUCT SPECIFICATION, 108-2055-1; BASED ON TELCORDIA GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS.
 COMPLIANT PIN AREA:
 0.5µm MIN MATTE TIN OVER BASE PLATING.



| | |
|--------|-------------|
| 3 | 2065657-2 |
| 8 | 2065657-1 |
| FINISH | PART NUMBER |

THIS DRAWING IS A CONTROLLED DOCUMENT.

| | | | |
|-------------|--|----------------------------|---|
| DIMENSIONS: | TOLERANCES UNLESS OTHERWISE SPECIFIED: | DWN J. K. SHOBER 10JAN2009 | NAME |
| mm | 0 PLC ±.01 | CHK N. SCHROLL 10JAN2009 | ASSEMBLY, Z-Pack Hm-Zd Plus, RECEPTACLE, 4 PAIR |
| | 1 PLC ±.02 | APVD N. SCHROLL 10JAN2009 | SIZE CAGE CODE DRAWING NO RESTRICTED TO |
| | 2 PLC ±.03 | PRODUCT SPEC | A100779C=2065657 |
| | 3 PLC ±.04 | APPLICATION SPEC | SCALE 8:1 SHEET 1 OF 1 REV B |
| | 4 PLC ±.05 | WEIGHT | |
| | ANGLES | CUSTOMER DRAWING | |
| MATERIAL | FINISH | | |
| SEE TABLE | | | |